

Description

The HSU0107 is the high cell density trenched P-ch MOSFETs, which provides excellent RDSON and efficiency for most of the small power switching and load switch applications.

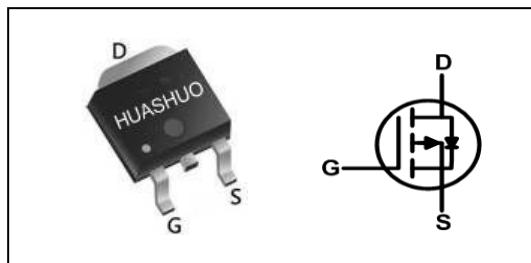
The HSU0107 meets the RoHS and Green Product requirement with full function reliability approved.

- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available
- Advanced high cell density Trench technology

Product Summary

V _{DS}	-100	V
R _{DS(ON),max}	650	mΩ
I _D	-4.1	A

TO252 Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-100	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ -10V ₁	-4.1	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ -10V ₁	-2.6	A
I _{DM}	Pulsed Drain Current ₂	-8.2	A
P _D @T _A =25°C	Total Power Dissipation ₃	2	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-ambient ₁	---	62	°C/W
R _{θJC}	Thermal Resistance Junction-Case ₁	---	6	°C/W

P-Ch 100V Fast Switching MOSFETs
Electrical Characteristics (T_J=25 °C, unless otherwise noted)

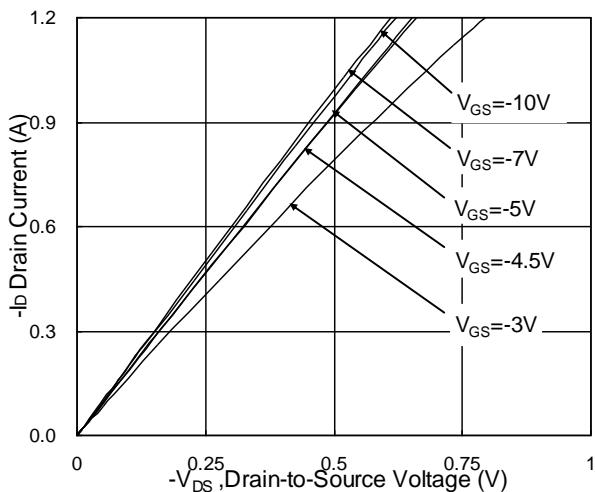
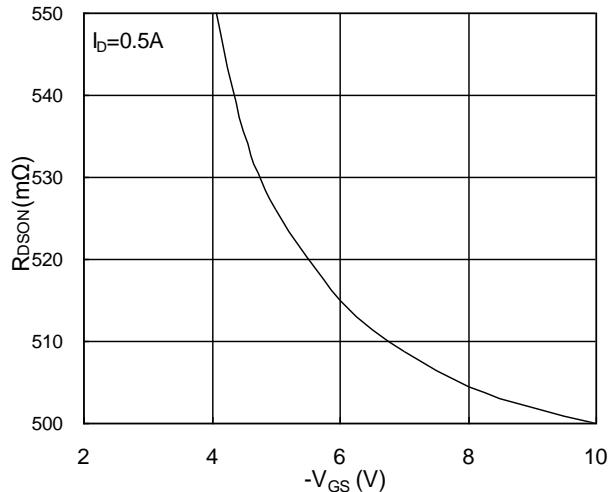
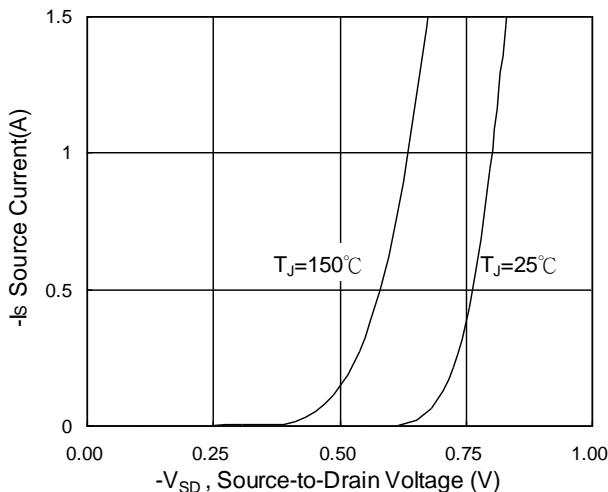
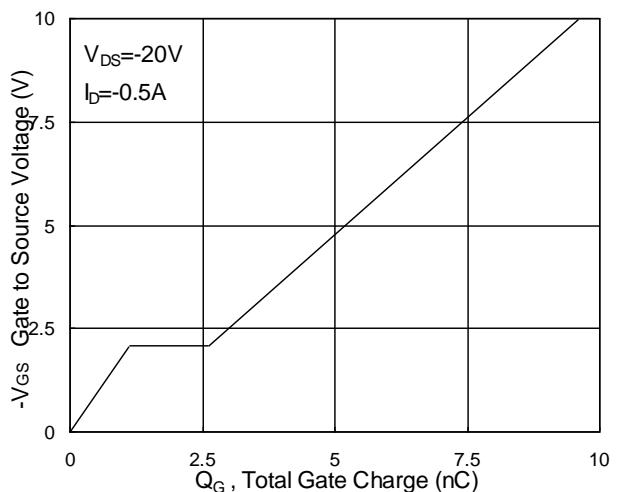
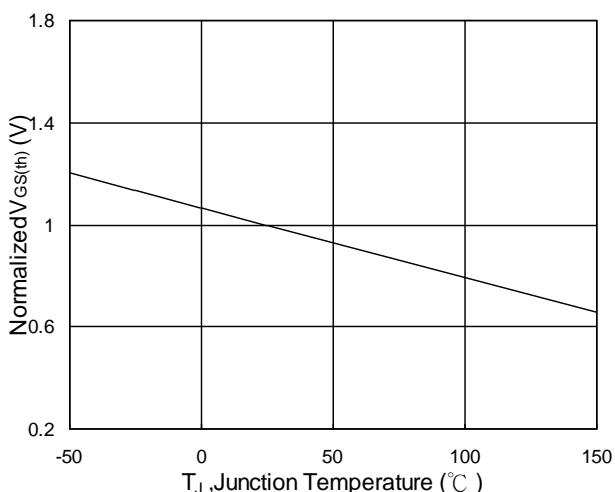
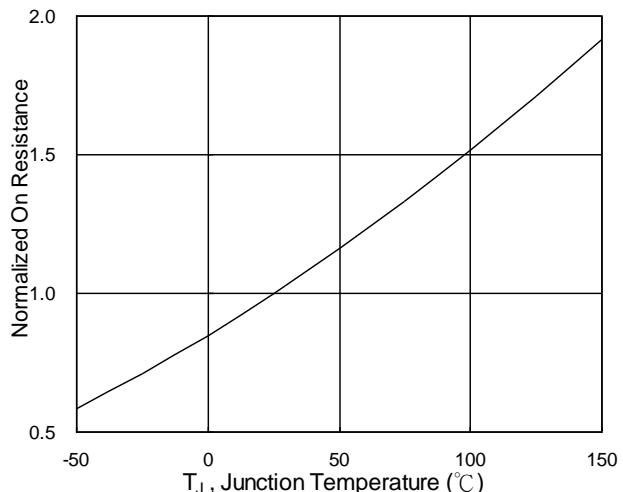
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250μA	-100	---	---	V
△BV _{DSS} /△T _J	BVDSS Temperature Coefficient	Reference to 25°C , I _D =-1mA	---	-0.0624	---	V/°C
R _{DSON}	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-1A	---	0.52	0.65	Ω
		V _{GS} =-4.5V , I _D =-0.5A	---	0.56	0.7	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250μA	-1.0	-1.5	-2.5	V
△V _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	4.5	---	mV/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-80V , V _{GS} =0V , T _J =25°C	---	---	10	uA
		V _{DS} =-80V , V _{GS} =0V , T _J =55°C	---	---	100	
I _{CSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =-5V , I _D =-1A	---	3	---	S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	---	16	32	Ω
Q _g	Total Gate Charge (-4.5V)	V _{DS} =-15V , V _{GS} =-4.5V , I _D =-1A	---	4.5	---	nC
Q _{gs}	Gate-Source Charge		---	1.14	---	
Q _{gd}	Gate-Drain Charge		---	1.5	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =-50V , V _{GS} =-10V , R _G =3.3Ω I _D =-1A	---	13.6	---	ns
T _r	Rise Time		---	6.8	---	
T _{d(off)}	Turn-Off Delay Time		---	34	---	
T _f	Fall Time		---	3	---	
C _{iss}	Input Capacitance	V _{DS} =-15V , V _{GS} =0V , f=1MHz	---	553	---	pF
C _{oss}	Output Capacitance		---	29	---	
C _{rss}	Reverse Transfer Capacitance		---	20	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current ^{1,4}	V _G =V _D =0V , Force Current	---	---	-4.1	A
I _{SM}	Pulsed Source Current ^{2,4}		---	---	-8.2	A
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _s =-1A , T _J =25°C	---	---	-1.2	V

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The power dissipation is limited by 150°C junction temperature
- 4.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

P-Ch 100V Fast Switching MOSFETs
Typical Characteristics

Fig.1 Typical Output Characteristics

Fig.2 On-Resistance vs. Gate-Source

Fig.3 Forward Characteristics Of Reverse

Fig.4 Gate-Charge Characteristics

Fig.5 Normalized $V_{GS(th)}$ vs. T_J

Fig.6 Normalized $R_{DS(on)}$ vs. T_J



P-Ch 100V Fast Switching MOSFETs

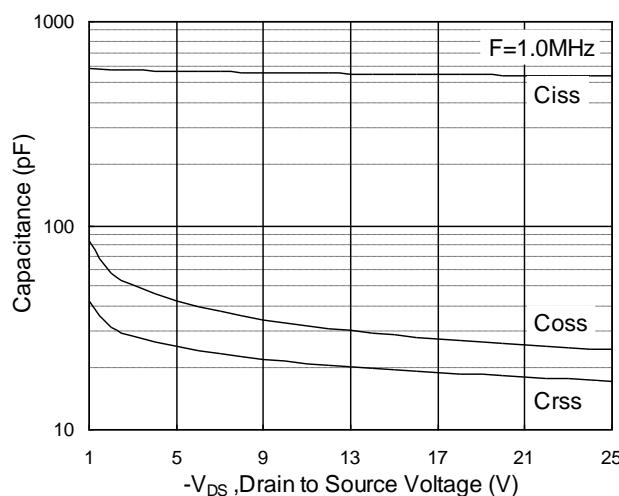


Fig.7 Capacitance

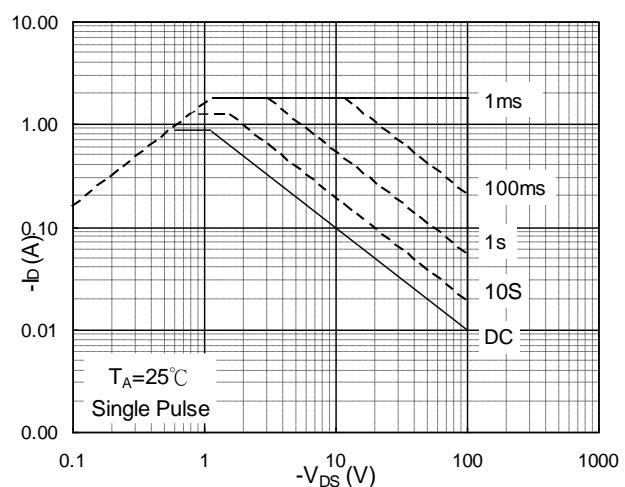


Fig.8 Safe Operating Area

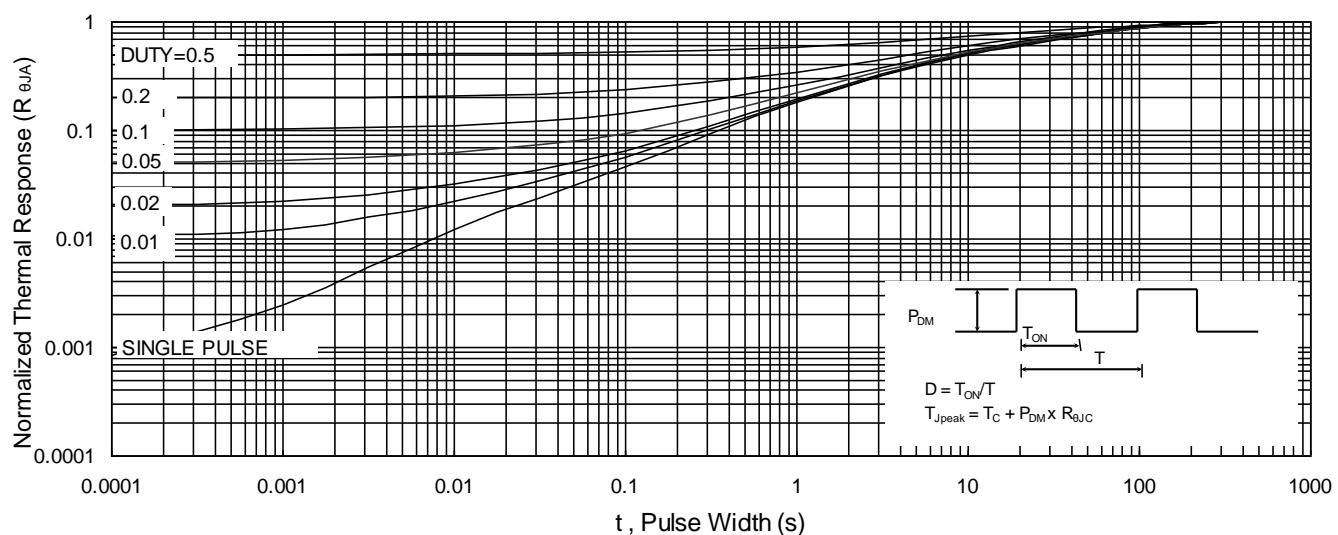


Fig.9 Normalized Maximum Transient Thermal Impedance

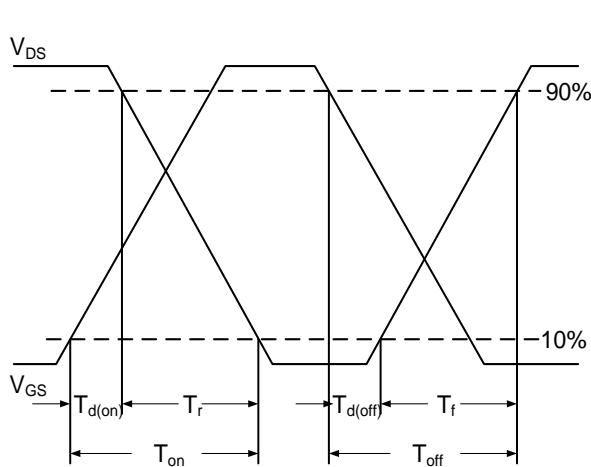


Fig.10 Switching Time Waveform

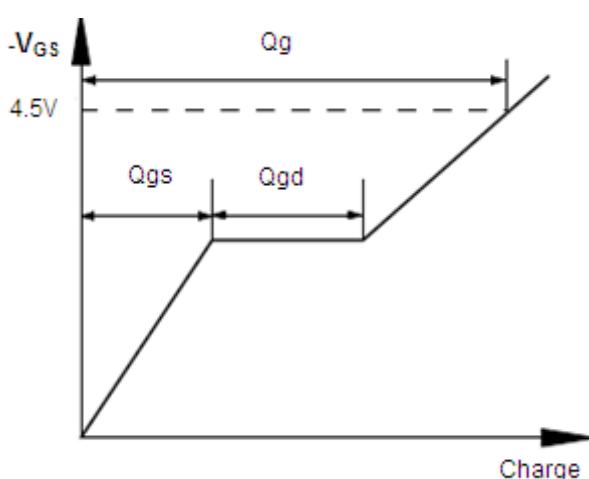
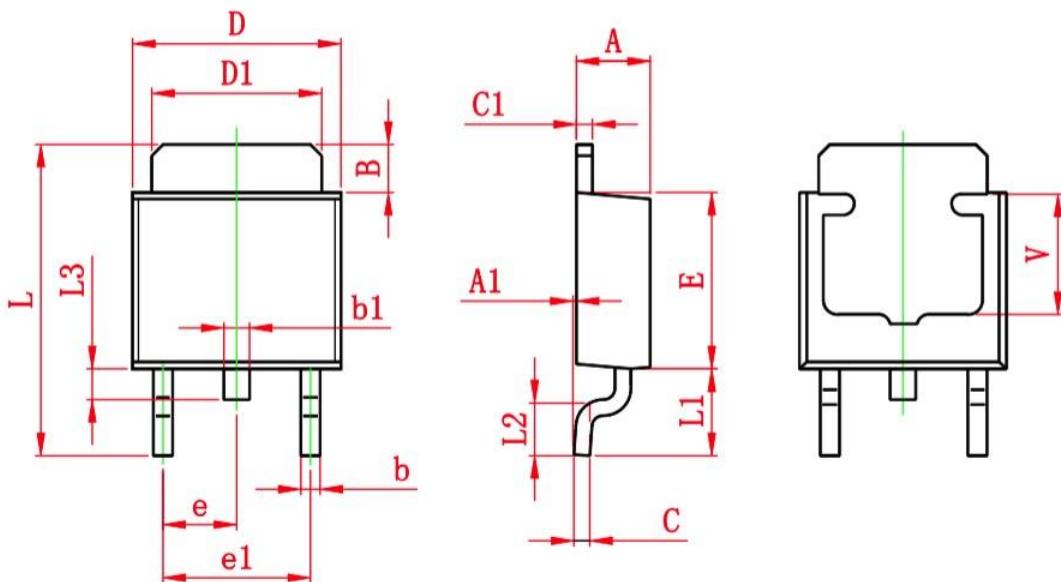


Fig.11 Gate Charge Waveform



Ordering Information

Part Number	Package code	Packaging
HSU0107	TO-252	2500/Tape&Reel



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

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